In-Situ Observation of Oxygen Exposed Hydrogen Terminated Silicon Surfaces

Hiroki OGAWA, Kenji ISHIKAWA, Masaru AOKI*, Shuzo FUJIMURA, Nobuo UENO**, Yasuhiro HORIIKE***, Yoshiya HARADA**

Process Development Div., C850, Fujitsu Ltd. 1015 Kamikodanaka, Nakahara-ku, Kawasaki, Kanagawa 211, Japan *Department of Chemistry, College of Arts and Science, The Univ. of Tokyo Komaba, Meguro, Tokyo 153, Japan **Department of Material Science, Faculty of Engineering, Chiba Univ. 1-33 Yayoi-cho, Inage-ku, Chiba 263, Japan ***Department of Electrical Engineering, Toyo Univ. 2100 Nakanodai, Kujirai, Kawagoe, Saitama 350, Japan

In-situ observation of hydrogen (H) terminated silicon (111) surface after exposure in 133 Pa dry O_2 was performed using Fourier transformed IR attenuated total reflection spectroscopy (FT-IR-ATR), X-ray photoelectron spectroscopy (XPS), Penning ionization electron spectroscopy (PIES), and ultraviolet photoelectron spectroscopy (UPS). The IR absorption peak attributed to the terminating Si-H bonds did not change at all after exposure in N₂ at 180 °C, while this absorption peak decreased after exposure in O_2 at 180 °C. Then XPS and ATR measurements could not confirm the formation of Si-O bonds. We considered that such decrease in IR absorption peak reflects the very early oxidation process.

1. INTRODUCTION

In our previous study¹), we have investigated the native oxide growth in pure water on atomically flat hydrogen (H) terminated silicon (Si) (111) surfaces using Fourier transformed infrared attenuated total reflection spectroscopy (FT-IR-ATR) and FT-IR reflection absorption spectroscopy (FT-IR-RAS). We then observed that the sharp IR absorption peak arising from Si-H bonds terminating the surface terraces²) (labeled by $M_{terrace}$ in Fig. 1) decreases with broadening in the early stage native oxide growth process as shown in Fig. 1. This phenomenon arose much earlier than the formation of Si-O bonds, we therefore suggested that such phenomenon reflects the progress of very early native oxide growth.

In this study, we performed in-situ observation of



2. EXPERIMENTAL

Samples used in this study were floating zone ptype Si(111) with resistivity of 100 Ω cm. Atomically flat H-terminated Si(111) surfaces prepared in NH₄F solution⁶) were employed as initial surfaces. We used two *insitu* observation systems, each one equips the sample





treatment chamber with temperature control and gas inlet system. One of the equipments furnishes with FT-IR-ATR and XPS, and the another furnishes PIES and UPS. IR light was internally reflected about 100 times in the sample Si prism for ATR measurement. In XPS measurement, MgK α line (hv=1253.6eV) was used as X-ray source, and we measured with 15° take-off angle to improve the surface sensitivity. The He I resonance line (hv=21.2eV) was used as a UV source in UPS measurement, and the He* metastable atoms (23S: 19.8eV) were used in PIES measurement. Oxygen exposure was performed in 133 Pa dry O₂^{3,4}) at comparatively low temperature not desorbed terminating H atoms.^{7,8})

3. RESULTS and DISCUSSION

Figure 2 shows p-polarized IR absorption spectra arising from Si-H bonds obtained for an initial surface and difference spectra between the initial surface and after exposure in N₂ or O₂ at various temperatures. In the case of initial surface, only the sharp absorption peak of Mterrace which is attributed to the Si-H bonds terminating surface terraces was observed.2) From this figure, we found that there is no spectral change after exposure in N2 at 180 °C and that the Mterrace peak decreases as the O2 exposure temperature or time increases. In addition, the absorption arising from Si-H bonds back-bonded with oxygen atom(s)9) at 2150-2250 cm-1 was not observed. XPS meaurements were also performed on these surfaces, and Si2p photoelectron spectra are shown in Fig. 3. We hardly observe the clear signal due to the intermediate silicon oxide or SiO2 at binding energy of 101-104eV in any cases. Figure 4 shows O1s photoelectron spectra measured at the same time. We found that the O1s spec-



Fig. 2 Change in IR absorption spectra arising from Si-H bonds as a function of exposure time in 133 Pa dry O_2 or N_2 . Spectra (b)-(f) are difference from spectrum obtained for initial surface (a).



Fig. 3 Change in Si2p photoelectron spectra as a function of exposure time in 133 Pa dry O_2 or N_2 . Dashed line means the spectrum obtained for the initial surface.



Fig. 4 Change in O1s photoelectron spectra as a function of exposure time in 133 Pa dry O_2 or N_2 . 0.5 monolayer oxygen atoms exsist on Si surface after treatment in 190°C O_2 for 30min.

tral intensity increases as the O_2 exposure temperature or time increase. It should be noticed that the amount of oxygen atoms is approximately 0.5 monolayer after treatment in O_2 at 190°C for 30 min, if all these oxygen atoms contribute to form Si-O bonds, the spectral intensity of Si2p photoelectron spectrum due to the Si bonded with oxygen atom have to be the level showed in Fig. 3. These results are summarized as follows: there is little Si-O bonds near the silicon surface, however, the M_{terrace} peak decreases as the exposure temperature or time increases, and these changes are linked with the increase in amounts of oxygen on the silicon surface. We therefore considered that the decrease in the M_{terrace} peak reflects



<u>Fig. 5</u> Change in PIES spectra as a function of exposure time in 133 Pa dry O_2 at various temperature.

progress of very early oxidation on H-terminated silicon surface.

We also performed similar experiment using PIES and UPS at almost same conditions. We then found that the PIES spectra change extremely increasing with temperature in 133 Pa dry O2 as shown in Fig. 5 and that the UPS spectra change slightly. Since the PIES spectra selectively reflect the information of the outermost surface5), change in the surface state due to O₂ exposure must occur at outermost surface. In addition, there is little Si-O bonds at the surface in this case form the results obtained for FT-IR-ATR and XPS measurements, we therefore took notice of O2 molecule. Figure 6 shows the difference PIES spectra between before and after exposure as shown in Fig. 5. Comparing the Fig. 6 and the PIES spectrum obtained for oxygen gas, we found that the 6.8 eV and 10.8 eV bands in Fig. 6 are due to the π orbital of adsorbed O2 molecule and that the both bands shifted 3.5 eV to higher kinetic energy. This results are possible to indicate that the adsorbed O2 molecule accepts the charge. Here, it must appear the band at 5.2 eV due to σ orbital of O₂ molecule, however we could not observe clearly. This reason was inferred that this band overlaps with the band due to the terminating H at the surface and/or the O2 molecule is placed at the surface as it cannot be observed by PIES. Anyway, since the band due to π orbital of O₂ molecule was observed, we considered O2 molecule lies on the surface.

4. SUMMARY

In-situ observation of H-terminated Si(111) surface after exposure in 133 Pa dry O₂ at 145~245 °C was performed using FT-IR-ATR, XPS, PIES, and UPS. The IR absorption peak attributed to the terminating Si-H bonds did not change at all after exposure in N₂ but this absorption peak decreased after exposure in O₂. Then



Fig. 6 Difference PIES spectra between before and after exposure as shown in Fig. 5.

XPS and ATR measurements could not confirm the formation of Si-O bonds. We therefore considered that such decrease in IR absorption peak reflects the very early oxidation process. The experimental results obtained by PIES and UPS show that then the O_2 molecule *lies* at the outermost surface.

ACKNOWLEDGEMENTS

We are grateful to H. Kubota, Y. Einaga, R. Kurosaki, M. Nagasaka and J. Kikuchi for their experimental assistance and valuable discussion.

REFERENCES

- S. Fujimura, H. Ogawa, K. Ishikawa, C. Inomata, and H. Mori: TECHNICAL REPORT OF IEICE, SDM93-7 43.
- G.S. Higashi, Y.J. Chabal, G.W. Trucks, and K. Raghavachari: Appl. Phys. Lett. 56 (1990) 656.
- K. Ohishi and T. Hattori: Jpn. J. Appl. Phys. 33 (1994) L675.
- Y. Shimizu, T. Aiba, K. Ohishi, and T. Hattori: Proceeding of Intern. Conf. on Advanced Microelectronic Devices and Processing (1994) 383.
- Y. Harada and H. Ozaki: Jpn. J. Appl. Phys. 26 (1987) 1201.
- G.S. Higashi, R.S. Becker, Y.J. Chabal, and A.J. Becker: Appl. Phys. Lett. 58 (1991) 1656.
- N. Hirashita, M. Kinoshita, I. Aikawa, and T. Ajioka Appl. Phys. Lett. 56 (1990) 451.
- Y. Kato, T. Ito, and A. Hiraki: Jpn. J. Appl. Phys. 27 (1988) L1406.
- Y. Nagasawa, H. Ishida, T. Takahagi, A. Ishitani, and H. Kuroda: Solid State Electronics 33 suppl. (1990) 129.
- 10) H. Ogawa, Y. Einaga, M. Aoki, S. Fujimura, N. Ueno, and Y. Harada: Ext. Abstr. 42nd Spring Meeting of the Japan Society of Applied Physics and Related Societies, Kanagawa, March, 29p-PA-11